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Plastic Medium-Power Silicon Transistors 2N6387, 2N6388

These devices are designed for general-purpose amplifier and low-speed switching applications.

Features

- High DC Current Gain h_{FE} = 2500 (Typ) @ I_C = 4.0 Adc
- Collector–Emitter Sustaining Voltage @ 100 mAdc
 V_{CEO(sus)} = 60 Vdc (Min) 2N6387

= 80 Vdc (Min) - 2N6388

- Low Collector-Emitter Saturation Voltage V_{CE(sat)} = 2.0 Vdc (Max) @ I_C = 5.0 Adc – 2N6387, 2N6388
- Monolithic Construction with Built-In Base-Emitter Shunt Resistors
- TO-220AB Compact Package
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS (Note 1)

| Rating | | Symbol | Value | Unit |
|--|------------------|-----------------------------------|--------------|-----------|
| Collector-Emitter Voltage | 2N6387 2N6388 | V _{CEO} | 60 80 | Vdc |
| Collector-Base Voltage | 2N6387 2N6388 | V _{CB} | 60 80 | Vdc |
| Emitter-Base Voltage | | V_{EB} | 5.0 | Vdc |
| Collector Current – Continuous – Peak | | ۱ _C | 10 15 | Adc |
| Base Current | | Ι _Β | 250 | mAdc |
| Total Power Dissipation @ $T_C = 25^{\circ}C$ Derate above 25°C | | PD | 65 0.52 | W W/°C |
| Total Power Dissipation @ T _A = 25°C Derate above 25°C | | P _D | 2.0 0.016 | W W/°C |
| Operating and Storage Junction, Temperature Range | | T _J , T _{stg} | -65 to +150 | °C |

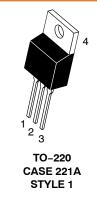
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Indicates JEDEC Registered Data.

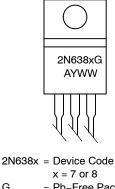
THERMAL CHARACTERISTICS

| Characteristics | Symbol | Max | Unit |
|---|-----------------|------|------|
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 1.92 | °C/W |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 62.5 | °C/W |

DARLINGTON NPN SILICON POWER TRANSISTORS 8 AND 10 AMPERES 65 WATTS, 60 – 80 VOLTS



MARKING DIAGRAM



| = | PD-Free P | rackage |
|---|-----------|----------|
| = | Assembly | Location |

- = Year
- WW = Work Week

G A

Υ

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------|---------------------|-----------------------|
| 2N6387G | TO–220 (Pb–Free) | 50 Units / Rail |
| 2N6388G | TO-220 (Pb-Free) | 50 Units / Rail |

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, <u>BRD8011/D.</u>

*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

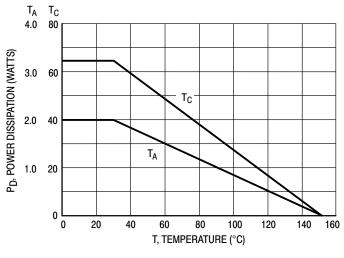


Figure 1. Power Derating

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted) (Note 2)

| Characteristic | | Symbol | Min | Max | Unit |
|--|--------------------------------------|-----------------------|-------------|--------------------------|--------------|
| OFF CHARACTERISTICS | | | | | |
| Collector–Emitter Sustaining Voltage (Note 3) $(I_{C} = 200 \text{ mAdc}, I_{B} = 0)$ | 2N6387 2N6388 | V _{CEO(sus)} | 60 80 | | Vdc |
| Collector Cutoff Current ($V_{CE} = 60 \text{ Vdc}, I_B = 0$) ($V_{CE} = 80 \text{ Vdc}, I_B = 0$) | 2N6387 2N6388 | I _{CEO} | | 1.0 1.0 | mAdc |
| | 2N6387 2N6388 2N6387 2N6388 | ICEX | | 300 300 3.0 3.0 | μAdc mAdc |
| Emitter Cutoff Current (V_{BE} = 5.0 Vdc, I_C = 0) | | I _{EBO} | - | 5.0 | mAdc |
| ON CHARACTERISTICS (Note 3) | | | | | |
| DC Current Gain (I _C = 5.0 Adc, V _{CE} = 3.0 Vdc) (I _C = 1 0 Adc, V _{CE} = 3.0 Vdc) | 2N6387, 2N6388 2N6387, 2N6388 | h _{FE} | 1000 100 | 20,000 - | _ |
| Collector–Emitter Saturation Voltage ($I_C = 5.0 \text{ Adc}, I_B = 0.01 \text{ Adc}$) ($I_C = 10 \text{ Adc}, I_B = 0.1 \text{ Adc}$) | 2N6387, 2N6388 2N6387, 2N6388 | V _{CE(sat)} | | 2.0 3.0 | Vdc |
| $\begin{array}{l} \text{Base-Emitter On Voltage} \\ (I_C = 5.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}) \\ (I_C = 10 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}) \end{array}$ | 2N6387, 2N6388 2N6387, 2N6388 | V _{BE(on)} | | 2.8 4.5 | Vdc |

DYNAMIC CHARACTERISTICS

| Small–Signal Current Gain (I _C = 1.0 Adc, V _{CE} = 5.0 Vdc, f _{test} = 1.0 MHz) | h _{fe} | 20 | - | - |
|--|-----------------|------|-----|----|
| Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz) | C _{ob} | - | 200 | pF |
| Small–Signal Current Gain (I _C = 1.0 Adc, V _{CE} = 5.0 Vdc, f = 1.0 kHz) | h _{fe} | 1000 | - | - |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Indicates JEDEC Registered Data.
 Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

2N6387, 2N6388

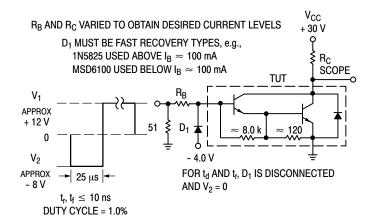
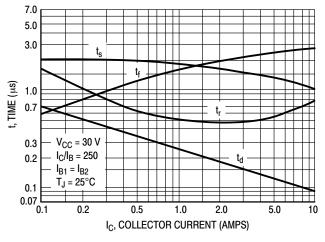
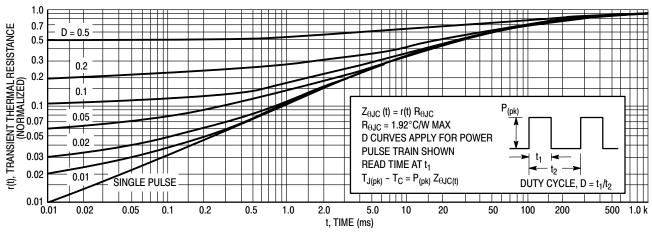


Figure 2. Switching Times Test Circuit









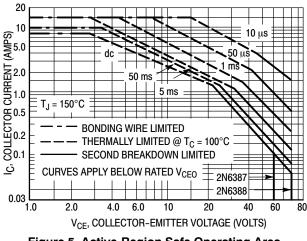
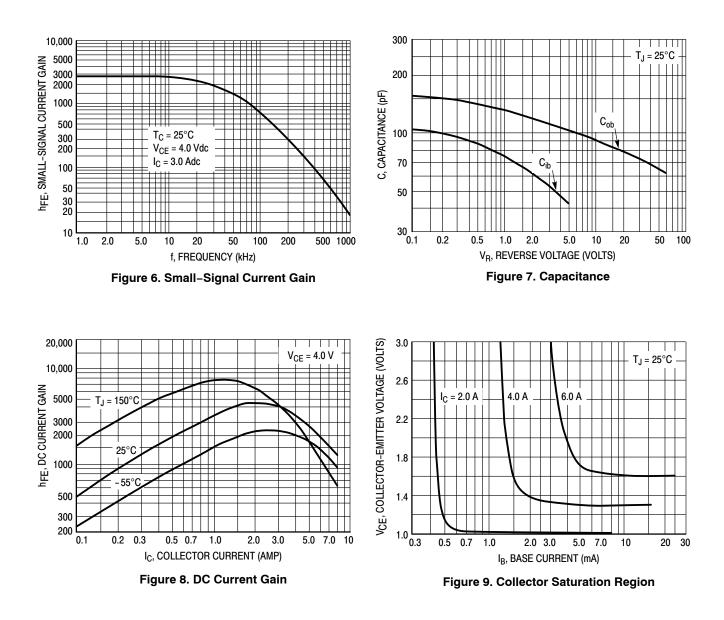
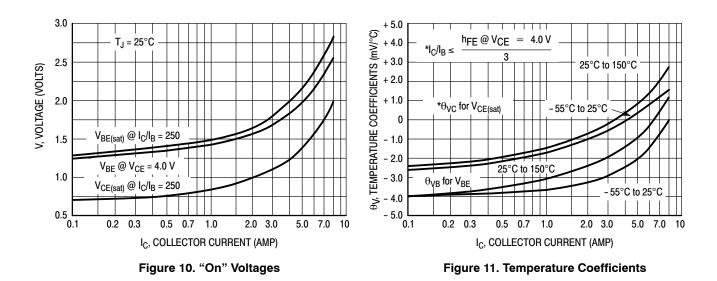


Figure 5. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150^{\circ}$ C; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} < 150^{\circ}$ C. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown





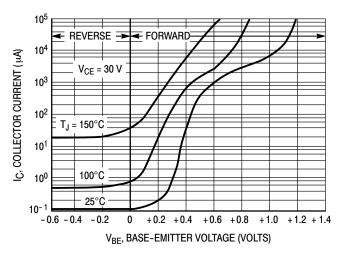


Figure 12. Collector Cut-Off Region

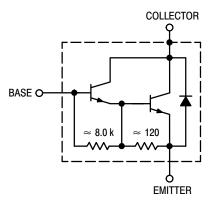


Figure 13. Darlington Schematic

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| | TO-22 CASE 2 ISSUE | 21A | | | | | DATE | 13 JAN 2022 |
|---|---|--------------------|------------------------------------|--|---|---|--------------|-------------|
| SCALE 1:1 | | PLANE 1 2 3. | . CONT . DIMEI LEA | ROLLING D NSION Z DE D IRREGUL/ WIDTH FOR | AND TOLERAI IMENSION: IN FINES A ZONI ARITIES ARE A F102 DEVICE | NCHES E WHERE AL ALLOWED. E = 1.35MM | L BODY AND | |
| A A | | | | INC | 1 | MILLIM | | |
| | Ŭ | | DIM | MIN. | MAX. | MIN. | MAX. | |
| 1 2 3 | | | A | 0.570 | 0.620 | 14.48 | 15.75 | |
| | | | B | 0.380 | 0.415 | 9.66 | 10.53 | |
| <u>╄</u> <u></u> | | | C D | 0.160 | 0.190 | 4.07 | 4.83 | |
| | | | F | 0.025 | 0.038 | 0.64 3.60 | 0.96 4.09 | |
| Z-J K | | | G | 0.095 | 0.101 | 2.42 | 2.66 | |
| | | | н | 0.110 | 0.161 | 2.42 | 4.10 | |
| | | | | 0.014 | 0.024 | 0.36 | 0.61 | |
| | | | ĸ | 0.500 | 0.562 | 12.70 | 14.27 | |
| ∨4 | R — | | L | 0.045 | 0.060 | 1.15 | 1.52 | |
| G | J → → | | N | 0.190 | 0.210 | 4.83 | 5.33 | |
| D | | | Q | 0.100 | 0.120 | 2.54 | 3.04 | |
| N | | | R | 0.080 | 0.110 | 2.04 | 2.79 | |
| | | | s | 0.045 | 0.055 | 1.15 | 1.41 | |
| | | | т | 0.235 | 0.255 | 5.97 | 6.47 | |
| | | | U | 0.000 | 0.050 | 0.00 | 1.27 | |
| | | | V | 0.045 | | 1.15 | | |
| | | | Z | | 0.080 | | 2.04 | |
| STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR | STYLE 2: PIN 1. BASE 2. EMITTER 3. COLLECTOR 4. EMITTER | 3. 0 | CATHODI NODE GATE NODE | | 2. MA 3. GA | in terminal In terminal Te In terminal | .2 | |
| STYLE 5: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN | STYLE 6: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE | 3. 0 | Cathodi Node Cathodi Node | E | STYLE 8: PIN 1. CA 2. AN 3. EX 4. AN | ode Ternal Trip | /DELAY | |
| STYLE 9: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR | STYLE 10: PIN 1. GATE 2. SOURCE 3. DRAIN 4. SOURCE | 3. 0 | OURCE | | 2. MA 3. GA | NIN TERMINAL NIN TERMINAL TE DT CONNECTI | .2 | |
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 TO-220
 PAGE 1 OF 1

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